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MINIMUM MATING HEIGHT (SEE NOTE 2)	ĸ
	J
MATING PROFILE	Н
	G
TAINLESS STEEL	F
AP: LCP UL94, V-0 COLOR BLACK CONDUCTIVE COPPER ALLOY ACTS: 0.75 MICRON MIN GOLD OVER 1.27 MICRON MIN NICKEL 3.18 MICRON MIN SILVER OVER 1.27 MICRON MIN NICKEL TANDARD PIN DRAWINGS: /ING 2032633080-SD, MIN. MATING DISTANCE 7.32MM DRAWING 2032630001-SD, MIN. MATING DISTANCE 7.67MM OUNT DRAWING 2032634185-SD, MIN. MATING DISTANCE 7.77MM	E
CATION: 2043130001-PS IFICATION: 2043130001-AS. SPEC FOR SOLDERING INFORMATION. FICATION: 2043650000-PK ITS WILL BE SUPPLIED TARNISH FREE OVER TIME. AP TO BE REMOVED AFTER SOLDERING.	D
OOUT OF BOTTOM FROM THE TOP. LASER MARKED APPROXIMATELY WHERE SHOWN WAT ON THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION ENT REV DESC:	С
0: 663471 N: RLOW 2021/04/23 D: JJONIAK 2021/05/11 AL REVISION: DOC TYPE DOC PART REVISION	- - B
N: NVELUSAMY 2019/01/24 2019/04/05 ANGLE PROJECTION ANGLE PROJECTION DRAWING D-SIZE 2121950 4 2019/04/05 MATERIAL NUMBER 2121950010 CUSTOMER CUSTOMER GENERAL MARKET 1 OF 1 3 2 1	A